

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t6658bhmse-2.5#trpbf

(Engineering Calculation)

MSOP-Exposed

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TOTAL MASS (g) : 0.034878

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000851	1000000	24399.3203125		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.013845	975000	396954.875		
		Iron (Fe)	7439-89-6	0.000341	24000	9776.93066406		
		Phosphorus (P)	7723-14-0	0.000004	300	114.685394287		
		Zinc (Zn)	7440-66-6	0.000010	700	286.713500977		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.014200	1000000	407133.15625		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	20357.375		
		External Plating Total:				0.000710	1000000	20357.375
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	2465.73608398		
Internal Plating Total:				0.000086	1000000	2465.73608398		
Die Attach	ELECTRICALLY INSULATING ADHESIVE	Silver (Ag)	7440-22-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000005	50000	143.356750488		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000027	300000	774.126464844		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000059	650000	1691.60974121		
Die Attach Total:				0.000091	1000000	2609.09301758		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.002439	130000	69929.421875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.015571	830000	446441.59375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000657	35000	18837.078125		
		Carbon Black (C)	1333-86-4	0.000094	5000	2695.10693359		
		Encapsulation Total:				0.018761	1000000	537903.1875
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000179	1000000	5132.17138672		
					TOTAL MASS (g) :	0.034878		